



MUR560

Ultrafast power diode

Rev.03 - 21 March 2018

Product data sheet

1. General description

Ultrafast power diode in a SMC package.

2. Features and benefits

- Fast switching
- SMC package
- High voltage capability
- Low forward voltage drop
- Low leakage current
- Low thermal resistance
- Soft recovery characteristic

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- High frequency switched-mode power supplies


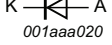
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit
Absolute maximum rating						
V_{RRM}	repetitive peak reverse voltage		600			V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; $T_{lead} \leq 96$ °C; Fig. 1 ; Fig. 2 ; Fig. 3	5			A
I_{FRM}	repetitive peak forward current	$\delta = 0.5$; $t_p = 25$ μ s; $T_{lead} \leq 96$ °C; square-wave pulse	10			A
I_{FSM}	non-repetitive peak forward current	$t_p = 10$ ms; $T_{j(init)} = 25$ °C; sine-wave pulse; Fig. 4	130			A
		$t_p = 8.3$ ms; $T_{j(init)} = 25$ °C; sine-wave pulse;	143			A
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
V_F	forward voltage	$I_F = 5$ A; $T_j = 25$ °C; Fig. 6	-	1.10	1.35	V
		$I_F = 5$ A; $T_j = 150$ °C; Fig. 6	-	0.9	1.15	V
Dynamic characteristics						
t_{rr}	reverse recovery time	$I_F = 1$ A; $V_R = 30$ V; $di_F/dt = 50$ A/ μ s; $T_j = 25$ °C; Fig. 7	-	45	-	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
MUR560	SMC	Hermetically sealed plastic package; SMC; 2 leads	SMC

7. Marking

Table 4. Marking codes

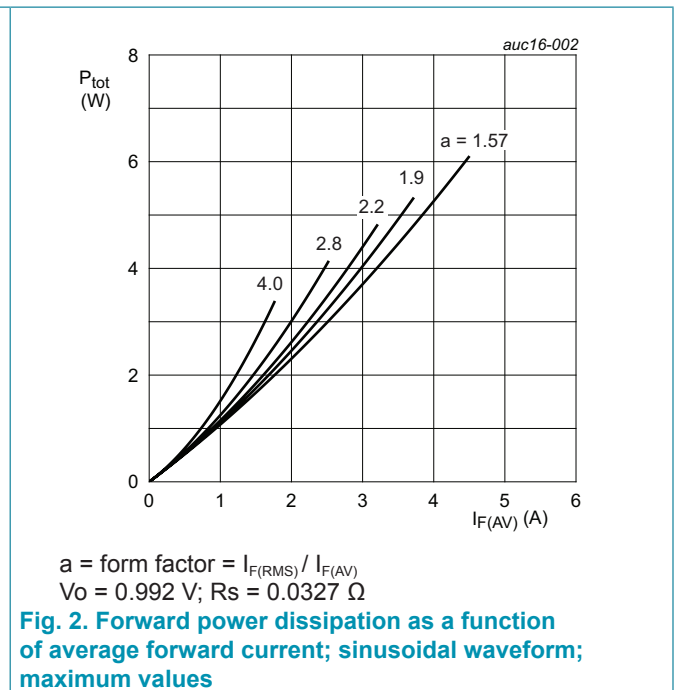
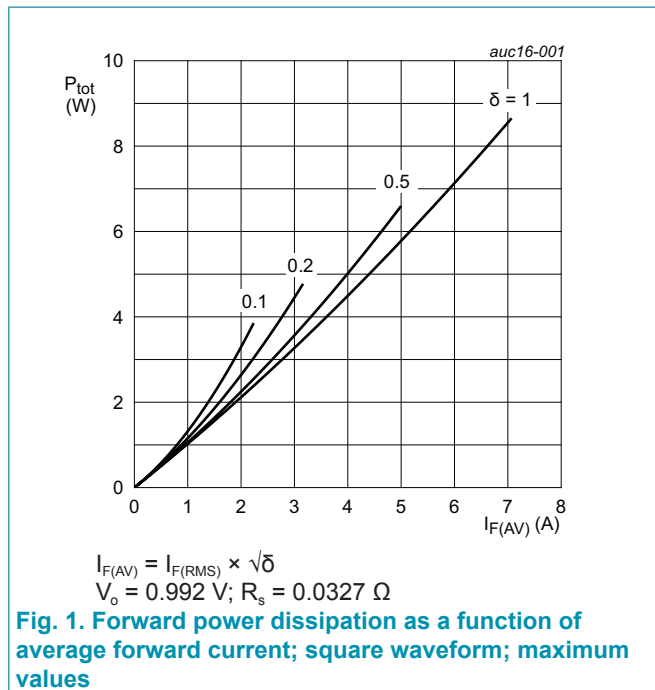
Type number	Marking codes
MUR560	560

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V_R	reverse voltage	DC	600	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; $T_{lead} \leq 96\text{ }^\circ\text{C}$; Fig. 1 ; Fig. 2 ; Fig. 3	5	A
I_{FRM}	repetitive peak forward current	$\delta = 0.5$; $t_p = 25\text{ }\mu\text{s}$; $T_{lead} \leq 96\text{ }^\circ\text{C}$; square-wave pulse	10	A
I_{FSM}	non-repetitive peak forward current	$t_p = 10\text{ ms}$; $T_{j(init)} = 25\text{ }^\circ\text{C}$; sine-wave pulse; Fig. 4	130	A
		$t_p = 8.3\text{ ms}$; $T_{j(init)} = 25\text{ }^\circ\text{C}$; sine-wave pulse;	143	A
T_{stg}	storage temperature		-65 to 175	$^\circ\text{C}$
T_j	junction temperature		175	$^\circ\text{C}$



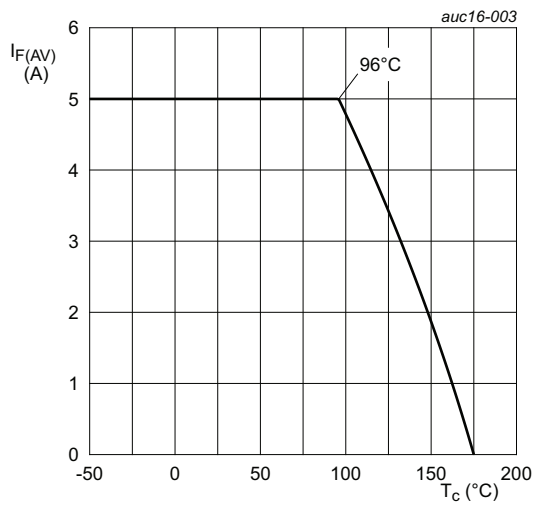


Fig. 3. Forward current as a function of case temperature; maximum values

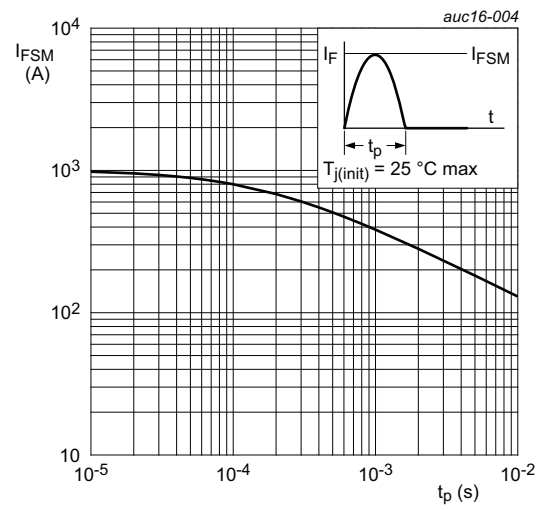


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	mounted on a minimum footprint printed-circuit board (FR4); Fig. 5	-	-	12	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	mounted on a minimum footprint printed-circuit board (FR4)	-	75	-	K/W

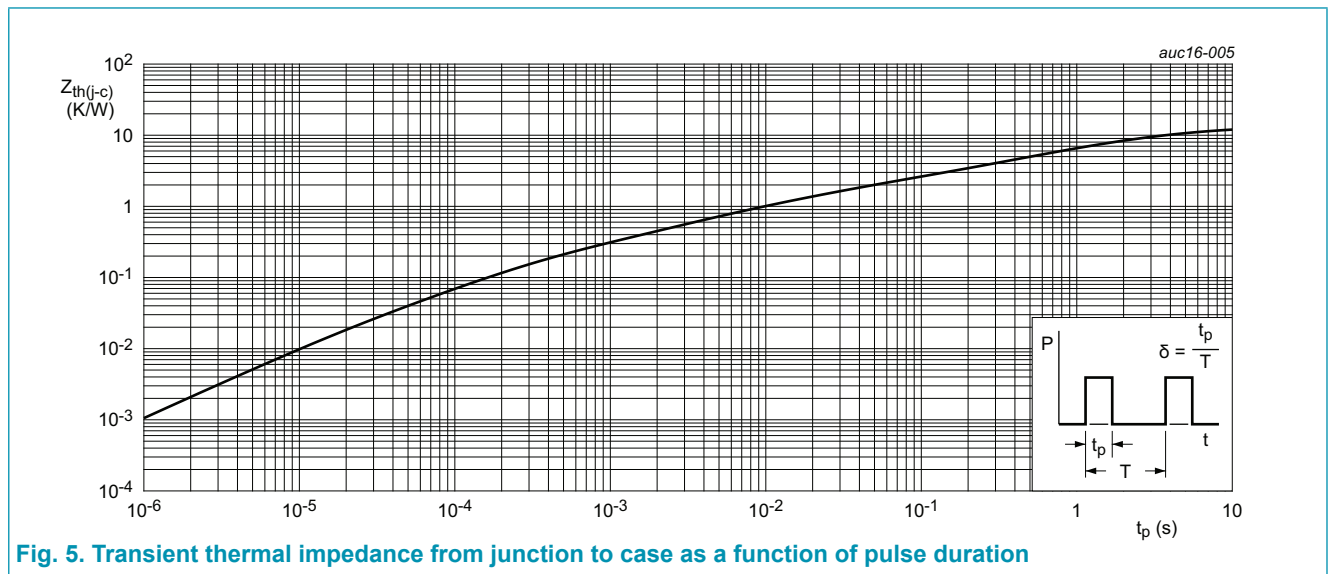
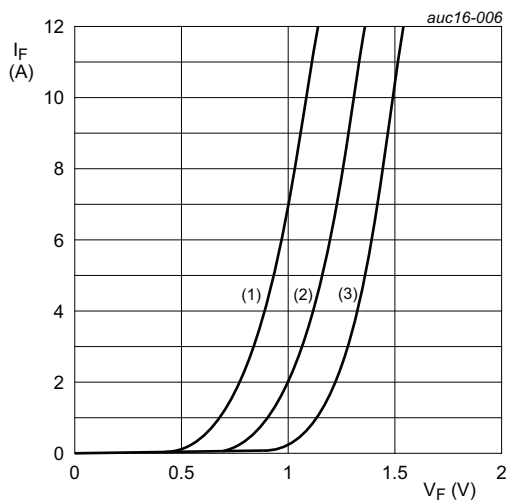


Fig. 5. Transient thermal impedance from junction to case as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
V _F	forward current	I _F = 5 A; T _j = 25 °C; Fig. 6	-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C; Fig. 6	-	0.9	1.15	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	3	µA
		V _R = 600 V; T _j = 150 °C	-	-	250	µA
Dynamic characteristics						
Q _r	reverse charge	I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 25 °C; Fig. 7	-	216	-	nC
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 125 °C; Fig. 7	-	420	-	nC
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 50 A/µs; T _j = 25 °C; Fig. 7	-	45	-	ns
		I _F = 0.5 A; I _R = 1 A; I _{R(meas)} = 0.25 A; T _j = 25 °C; Step recovery	-	-	65	ns
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 25 °C; Fig. 7	-	64	-	ns
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 125 °C; Fig. 7	-	88	-	ns
I _{RM}	peak reverse recovery current	I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 25 °C; Fig. 7	-	6.7	-	A
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/µs; T _j = 125 °C; Fig. 7	-	9.5	-	A
E _{as}	non-repetitive avalanche energy	I _R = 1.2 A; T _{j(init)} = 25 °C; L = 15 mH	10.8	-	-	mJ



V₀ = 0.992 V; R_s = 0.0327 Ω
 (1) T_j = 150 °C; typical values
 (2) T_j = 150 °C; maximum values
 (3) T_j = 25 °C; maximum values

Fig. 6. Forward current as a function of forward voltage

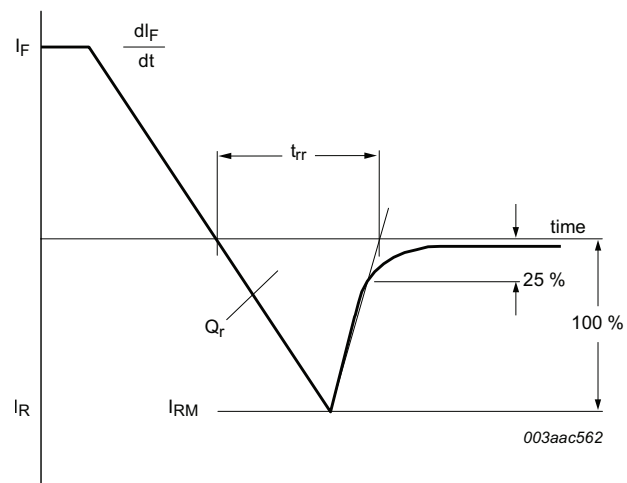
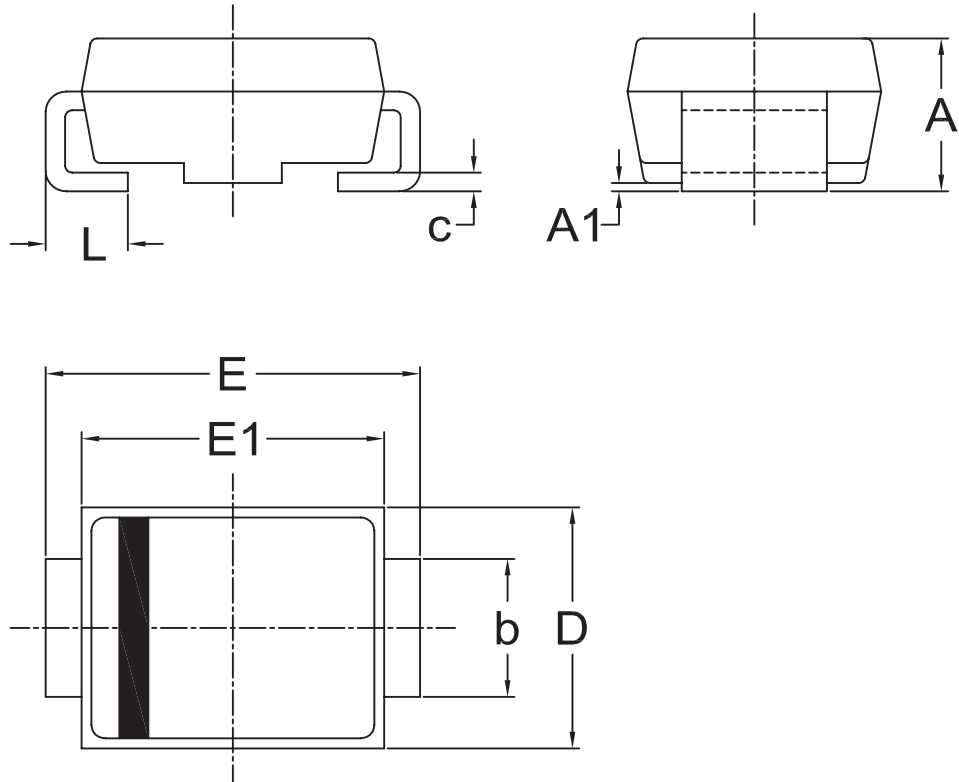


Fig. 7. Reverse recovery definitions; ramp recovery

11. Package outline



UNIT		A	A1	b	c	D	E	E1	L
mm	Max	2.40	0.22	3.18	0.31	6.22	8.13	7.11	1.52
	Min	2.01	0.05	2.92	0.15	5.59	7.70	6.60	0.76

Remark: Dimensions D and E1 do not include mold flash.

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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